# onsemi

# AFGH4L40T120RWD-STD

#### Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 4–lead package, this device offers good performance with low on state voltage and low switching losses for both hard and soft switching topologies in automotive applications.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature  $T_J = 175^{\circ}C$
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

#### Applications

• Automotive E-compressor / Automotive EV PTC Heater / OBC

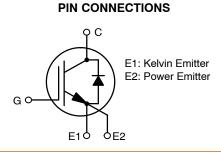
#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

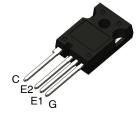
Param	Symbol	Value	Unit	
Collector-to-Emitter Volta	V <sub>CE</sub>	1200	V	
Gate-to-Emitter Voltage	V <sub>GE</sub>	±20		
Transient Gate-to-Emitte	1	±30		
Collector Current	$T_{C} = 25^{\circ}C$	Ι <sub>C</sub>	80	A
	$T_{\rm C} = 100^{\circ}{\rm C}$	1	40	
Power Dissipation	$T_{C} = 25^{\circ}C$	PD	416	W
	$T_{\rm C} = 100^{\circ}{\rm C}$	1	208	
Pulsed Collector Current	T <sub>C</sub> = 25°C, tp = 10 μs (Note 1)	I <sub>CM</sub>	120	A
Diode Forward	$T_{C} = 25^{\circ}C$	١ <sub>F</sub>	80	
Current	$T_C = 100^{\circ}C$		40	
Pulsed Diode Maximum Forward Current	<b>0</b> ,		120	
Short Circuit Withstand T $V_{GE}$ = 15 V, $V_{CC}$ = 800 V,	T <sub>SC</sub>	6	μs	
Operating Junction and S Range	T <sub>J</sub> , T <sub>stg</sub>	– 55 to +175	°C	
Lead Temperature for Sol	ΤL	260		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature

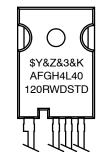
BV <sub>CES</sub>	V <sub>CE(sat)</sub> TYP	I <sub>C</sub> MAX
1200 V	1.67 V	40 A





TO-247-4LD CASE 340CJ

#### MARKING DIAGRAM



- \$Y = onsemi Logo
- &Z = Assembly Plant Code
- &3 = 3–Digit Date Code
- &K = 2-Digit Lot Traceability Code

AFGH4L40120RWDSTD = Specific Device code

#### **ORDERING INFORMATION**

Device	Package	Shipping			
AFGH4L40T120RWD-STD	TO-247-4L (Pb-Free)	30 Units / Tube			

#### THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.36	°C/W
Thermal Resistance, Junction-to-Case for Diode	$R_{\theta JCD}$	0.66	
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	40	

#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

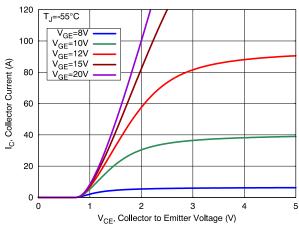
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	<b>-</b>		-	-	-	-
Collector-to-Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE}$ = 0 V, I <sub>C</sub> = 1 mA	1200	-	_	V
Collector-to-Emitter Breakdown Voltage Temperature Coefficient	$\Delta BV_{CES}/\Delta T_{J}$	$V_{GE}$ = 0 V, I <sub>C</sub> = 9.99 mA	-	1226	_	mV/°C
Zero Gate Voltage Collector Current	I <sub>CES</sub>	$V_{GE}$ = 0 V, $V_{CE}$ = $V_{CES}$	-	-	40	μA
Gate-to-Emitter Leakage Current	I <sub>GES</sub>	$V_{GE}$ = ±20 V, $V_{CE}$ = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GE(th)</sub>	$V_{GE} = V_{CE}$ , $I_C = 40$ mA	5.10	6	6.90	V
Collector-to-Emitter Saturation	V <sub>CE(sat)</sub>	$V_{GE}$ = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 25°C	-	1.67	2.00	V
Voltage		$V_{GE}$ = 15 V, $I_{C}$ = 40 A, $T_{J}$ = 175°C	-	2.12	-	1
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>IES</sub>	$V_{CE}$ = 30 V, $V_{GE}$ = 0 V, f = 1 MHz	-	3054	-	pF
Output Capacitance	C <sub>OES</sub>		-	126	-	
Reverse Transfer Capacitance	C <sub>RES</sub>		-	15.4	-	
Total Gate Charge	Q <sub>G</sub>	$V_{CE}$ = 600 V, $V_{GE}$ = 15 V, $I_{C}$ = 40 A	-	112	-	nC
Gate-to-Emitter Charge	Q <sub>GE</sub>		-	29.6	-	
Gate-to-Collector Charge	Q <sub>GC</sub>		-	51.1	-	
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CE}$ = 600 V, $V_{GE}$ = 15 V, I <sub>C</sub> = 20 A, R <sub>G</sub> = 6 Ω,	-	37.2	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm C}$ = 20 A, $H_{\rm G}$ = 6 $\Omega$ , $T_{\rm J}$ = 25°C	-	200	-	1
Rise Time	t <sub>r</sub>		-	15	-	
Fall Time	t <sub>f</sub>		-	146	-	
Turn-On Switching Loss	E <sub>on</sub>		-	0.54	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	0.99	-	
Total Switching Loss	E <sub>ts</sub>		-	1.54	-	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	40.2	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm C}$ = 40 Å, $R_{\rm G}$ = 6 Ω, $T_{\rm J}$ = 25°C	-	164	-	
Rise Time	t <sub>r</sub>		-	21.9	-	
Fall Time	t <sub>f</sub>		-	90.1	-	
Turn-On Switching Loss	E <sub>on</sub>		-	1.56	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	1.22	-	
Total Switching Loss	E <sub>ts</sub>		-	2.79	-	

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

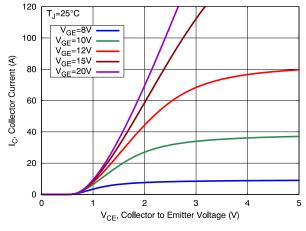
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>CE</sub> = 600 V, V <sub>GE</sub> = 15 V,	-	41.4	_	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	<sup>−</sup> I <sub>C</sub> = 20 A, R <sub>G</sub> = 6 Ω, T <sub>J</sub> = 175°C	-	270	-	
Rise Time	t <sub>r</sub>	·	-	25.5	_	
Fall Time	t <sub>f</sub>		-	284	-	
Turn–On Switching Loss	E <sub>on</sub>		-	1	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	1.81	-	
Total Switching Loss	E <sub>ts</sub>		-	2.81	-	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 15 \text{ V},$	-	46.4	_	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	I <sub>C</sub> = 40 A, R <sub>G</sub> = 6 Ω, T <sub>J</sub> = 175°C	-	211	_	
Rise Time	t <sub>r</sub>		-	38	-	
Fall Time	t <sub>f</sub>		-	168	_	
Turn-On Switching Loss	E <sub>on</sub>		-	3.05	-	mJ
Turn–Off Switching Loss	E <sub>off</sub>		-	2.15	_	
Total Switching Loss	E <sub>ts</sub>		-	5.19	_	
DIODE CHARACTERISTICS						
Forward Voltage	V <sub>F</sub>	$I_F = 40 \text{ A}, \text{ T}_J = 25^{\circ}\text{C}$	-	1.99	2.36	V
		I <sub>F</sub> = 40 A, T <sub>J</sub> = 175°C	-	2.06	-	
DIODE SWITCHING CHARACTERIS	TICS, INDUCTIVE	LOAD				
Reverse Recovery Time	t <sub>rr</sub>	$V_{\rm R} = 600 \text{ V}, \text{ I}_{\rm F} = 20 \text{ A},$	-	161	_	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$dI_F/dt = 500 \text{ A}/\mu \text{s}, T_J = 25^{\circ}\text{C}$	-	1732	-	nC
Reverse Recovery Energy	E <sub>rec</sub>		-	0.52	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		-	25.3	-	А
Reverse Recovery Time	t <sub>rr</sub>	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$	-	192	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$dI_F/dt = 500 \text{ A}/\mu \text{s}, T_J = 25^{\circ}\text{C}$	-	3051	-	nC
Reverse Recovery Energy	E <sub>rec</sub>		-	0.69	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		-	35.8	-	А
Reverse Recovery Time	t <sub>rr</sub>	$V_{\rm R} = 600 \text{ V}, \text{ I}_{\rm F} = 20 \text{ A},$	-	215	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt = 500 A/µs, T <sub>J</sub> = 175°C	-	2724	-	nC
Reverse Recovery Energy	E <sub>rec</sub>		-	0.97	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		-	30	-	А
Reverse Recovery Time	t <sub>rr</sub>	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 40 \text{ A},$	-	256	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt = 500 A/µs, T <sub>J</sub> = 175°C	-	4974	-	nC
Reverse Recovery Energy	E <sub>rec</sub>		-	1.35	-	mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>		_	43.2	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL CHARACTERISTICS**









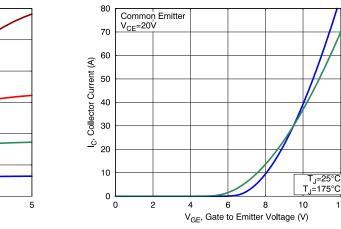
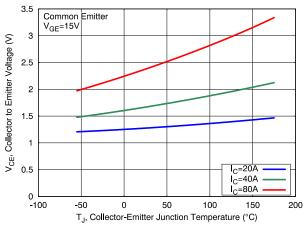


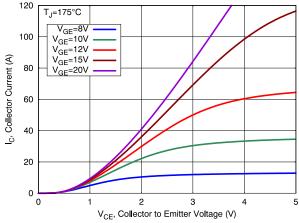
Figure 4. Transfer Characteristics

12

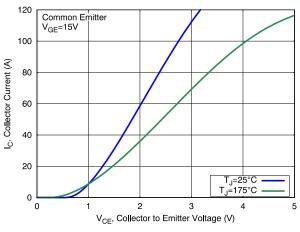
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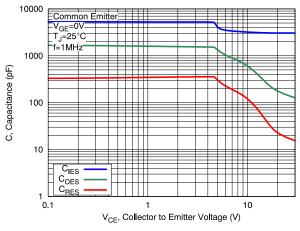


**Figure 3. Output Characteristics** 



**Figure 5. Saturation Characteristics** 

# **TYPICAL CHARACTERISTICS**





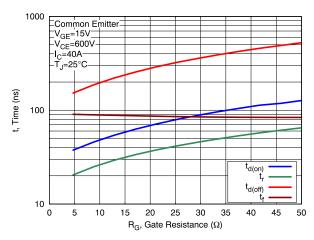


Figure 9. Switching Time vs Gate Resistance

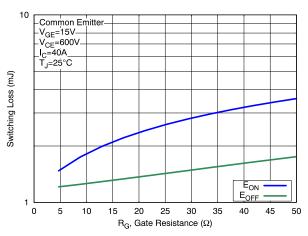
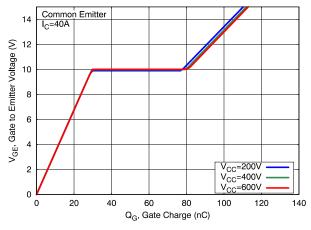


Figure 11. Switching Loss vs Gate Resistance





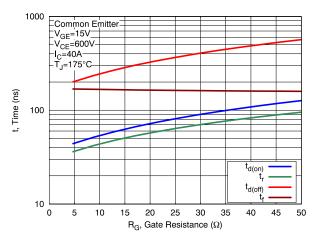


Figure 10. Switching Time vs Gate Resistance

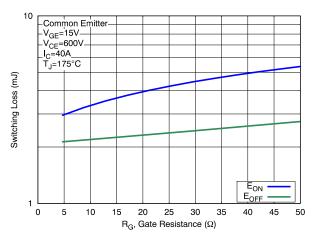
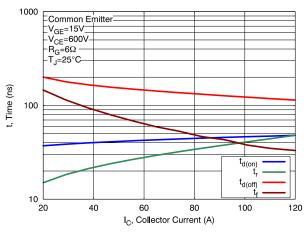
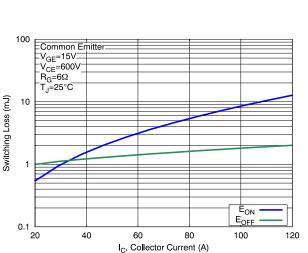


Figure 12. Switching Loss vs Gate Resistance

# **TYPICAL CHARACTERISTICS**









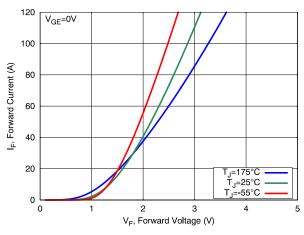


Figure 17. Diode Forward Characteristics

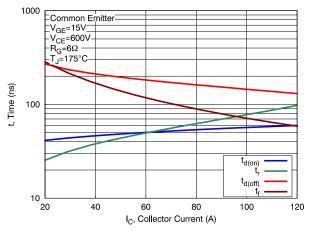


Figure 14. Switching Time vs Collector Current

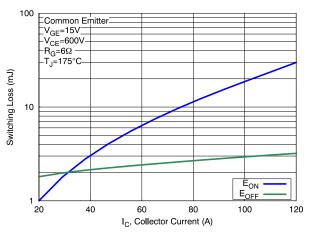


Figure 16. Switching Loss vs Collector Current

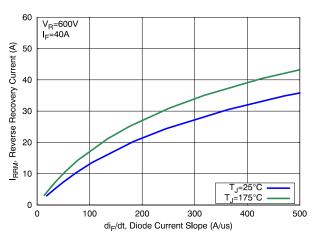
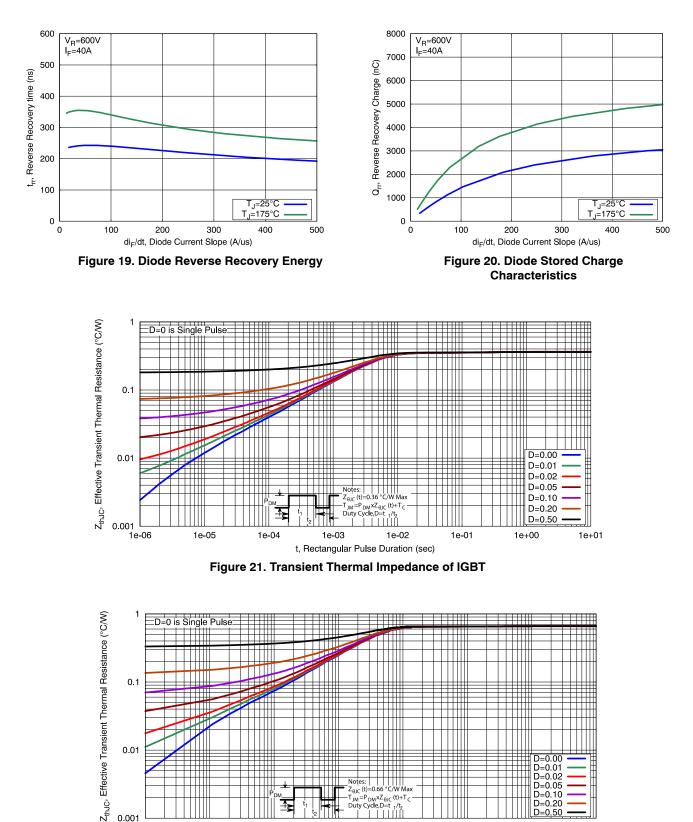


Figure 18. Diode Reverse Recovery Current

#### **TYPICAL CHARACTERISTICS**



1e-05

0.001 1e-06 ₹

1e-04

T<sub>JM</sub>=P<sub>DM</sub>xZ<sub>θJC</sub>(t)+T<sub>0</sub> Duty Cycle,D=t<sub>1</sub>/t<sub>2</sub>

t, Rectangular Pulse Duration (sec)

1e-02

Notes: Z<sub>θJC</sub> (t)=0.66 °C/W Max

1e-03

Figure 22. Transient Thermal Impedance of Diode

1e-01

D=0.00 D=0.01 D=0.02 D=0.05

D=0.10 D=0.20

D=0.50

1e+00



TO-247-4LD CASE 340CJ **ISSUE A** 

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

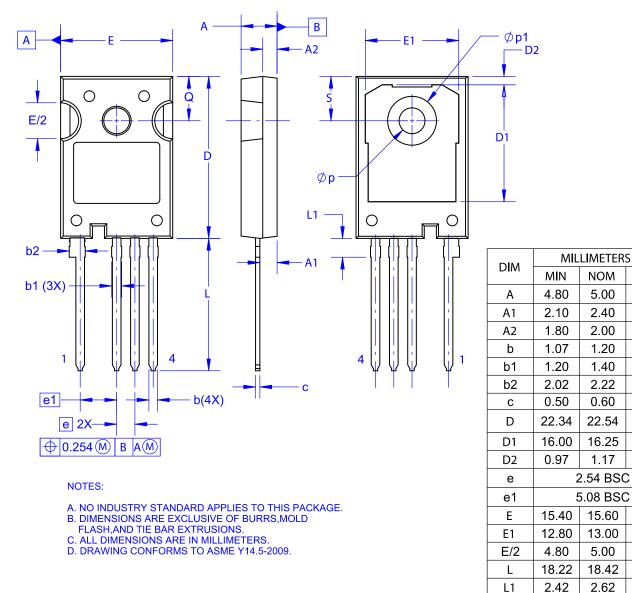
18.62

2.82

3.80

7.00 6.37

6.37



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